Patent



In re Application of Tan, Hock Chuan et al. 10/068,159 Serial No. 8043 Confirmation No. Filing Date February 5, 2002 Stacked Die in Die BGA Package For Group Art Unit 2812 CERTIFICATION UNDER 37 CFR 1.8(a) and 1.10 I hereby certify that, on the date shown below, this correspondence is being: Mailing deposited with the United States Postal Service in an envelope addressed to the Assistant Commissioner for Patents, Washington, D.C. 20231 37 CFR 1.8(a) with sufficient postage as first class mail 37 CFR 1.10 As "Express Mail Post Office to Addressee" Transmission transmitted by facsimile to Fax No.: addressed to Examiner at the Patent and Tradem

Assistant Commissioner for Patents Washington, D.C. 20231

## INFORMATION DISCLOSURE STATEMENT UNDER 37 C.F.R. §1.97/98

In compliance with Applicant's duty of disclosure as set forth in 37 C.F.R. §1.56, listed on the attached equivalent to Form PTO-1449 are those patents and other publications known to the Applicant which may be considered material to the patentability of the claims of the above-captioned application.

The Applicant respectfully requests that the documents listed on the attached equivalent to Form PTO-1449 be considered by the Examiner, that these references be made of record in the present applicant, and that an initialed copy of the attached equivalent to Form PTO-1449 be returned to the undersigned in accordance with MPEP 609.

Respectfully submitted,

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P.O. ADDRESS:

Dated: April 29

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